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# 10-FY07HVA050RG01-L984F48

datasheet

flowPACK 1 H6.5

650 V / 50 A

## Features

- Innovative H6.5 topology
- Optimized for bidirectional operation
- Integrated temperature sensor
- Low inductance housing

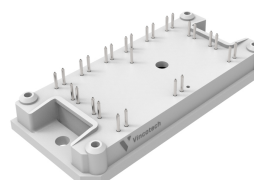
## Target applications

- Energy Storage Systems

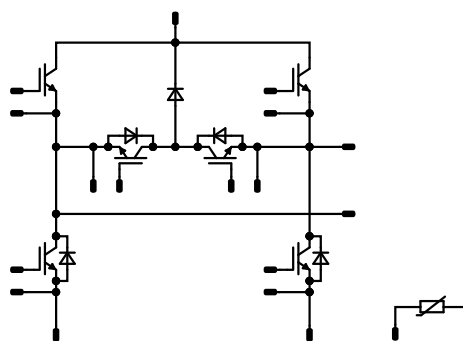
## Types

- 10-FY07HVA050RG01-L984F48

## flow 1 12 mm housing



## Schematic





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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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### Buck Switch

Collector-emitter voltage	$V_{CES}$		650	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	77	W
Gate-emitter voltage	$V_{GES}$		$\pm 30$	V
Maximum junction temperature	$T_{jmax}$		175	°C

### Buck Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	42	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	61	W
Maximum junction temperature	$T_{jmax}$		175	°C

### Boost Switch

Collector-emitter voltage	$V_{CES}$		650	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	77	W
Gate-emitter voltage	$V_{GES}$		$\pm 30$	V
Maximum junction temperature	$T_{jmax}$		175	°C



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	42	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	61	W
Maximum junction temperature	$T_{jmax}$		175	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			7,85	mm
Comparative Tracking Index	CTI		≥ 200	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]		Min	Typ	Max	

### Buck Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			5	0,033	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	25 125 150		1,5 1,66 1,7	1,9 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25			0,01	mA
Gate-emitter leakage current	$I_{GES}$		30	0		25			0,2	µA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ Mhz}$	0	30	25			4200		pF
Output capacitance	$C_{oes}$							104		pF
Reverse transfer capacitance	$C_{res}$							79		pF
Gate charge	$Q_g$		15	400	50	25		141		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,23		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	-5/15	400	50	25 125 150		41,8 40,59 39,93		ns
Rise time	$t_r$					25 125 150		12,59 13,07 13,27		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		101,16 114,77 118,72		ns
Fall time	$t_f$					25 125 150		35,63 51,43 50,17		ns
Turn-on energy (per pulse)	$E_{on}$					25 125 150		0,45 0,647 0,704		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		0,886 1,19 1,28		mWs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Buck Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		1,51 1,57 1,54	1,9 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_i = 650$ V				25			10	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,55		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=5045$ A/µs $di/dt=4662$ A/µs $di/dt=4695$ A/µs	-5/15	400	50	25 125 150		89,79 102,36 106,32		A
Reverse recovery time	$t_{rr}$					25 125 150		37,76 65,95 76,91		ns
Recovered charge	$Q_r$					25 125 150		1,86 2,78 3,24		µC
Reverse recovered energy	$E_{rec}$					25 125 150		0,658 0,931 1,07		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		4511,29 4761,63 4540,71		A/µs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			5	0,033	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	25 125 150		1,5 1,66 1,7	1,9 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25			0,01	mA
Gate-emitter leakage current	$I_{GES}$		30	0		25			0,2	µA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ Mhz}$	0	30	25			4200		pF
Output capacitance	$C_{oes}$							104		pF
Reverse transfer capacitance	$C_{res}$							79		pF
Gate charge	$Q_g$		15	400	50	25		141		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,23		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	-5/15	400	50	25 125 150		43,54 42,41 42,13		ns
Rise time	$t_r$					25 125 150		12,84 13,45 13,84		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		100,03 112,83 116,89		ns
Fall time	$t_f$					25 125 150		33,51 36,72 38,15		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD}=1,73 \mu\text{C}$ $Q_{tFWD}=2,36 \mu\text{C}$ $Q_{tFWD}=3,07 \mu\text{C}$				25 125 150		0,372 0,486 0,532		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		0,849 1,14 1,23		mWs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Boost Diode

#### Static

Forward voltage	$V_F$				50	25 125 150		1,51 1,57 1,54	1,9 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_i = 650$ V				25			10	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,55		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=5038$ A/µs $di/dt=4365$ A/µs $di/dt=4705$ A/µs	-5/15	400	50	25 125 150		83,29 90,95 94,29		A
Reverse recovery time	$t_{rr}$					25 125 150		37,48 47,93 84,18		ns
Recovered charge	$Q_r$					25 125 150		1,73 2,36 3,07		µC
Reverse recovered energy	$E_{rec}$					25 125 150		0,564 0,735 0,973		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		4237,78 4143,6 4114,86		A/µs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$					25		130		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



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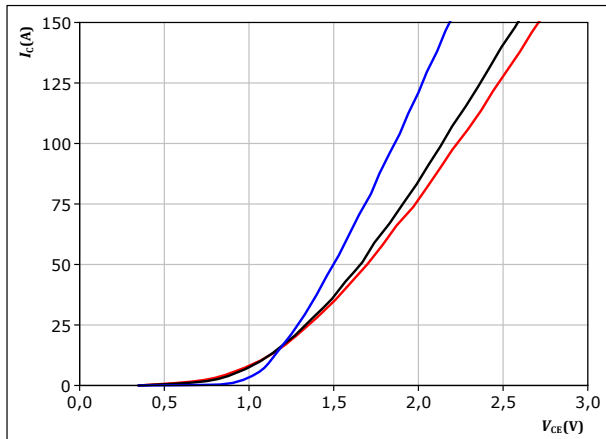
# 10-FY07HVA050RG01-L984F48 datasheet

## Buck Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



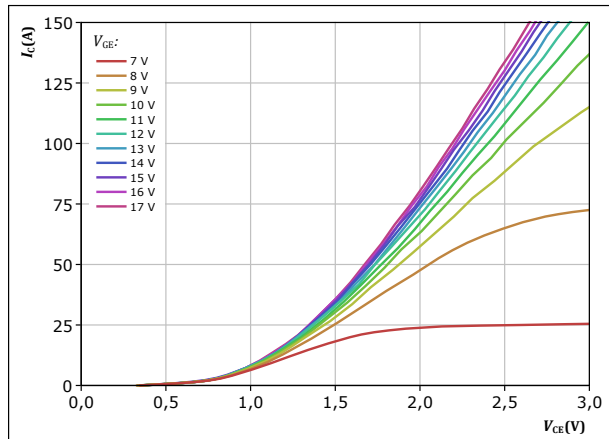
$t_p = 250 \mu s$   
 $V_{GE} = 15 V$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

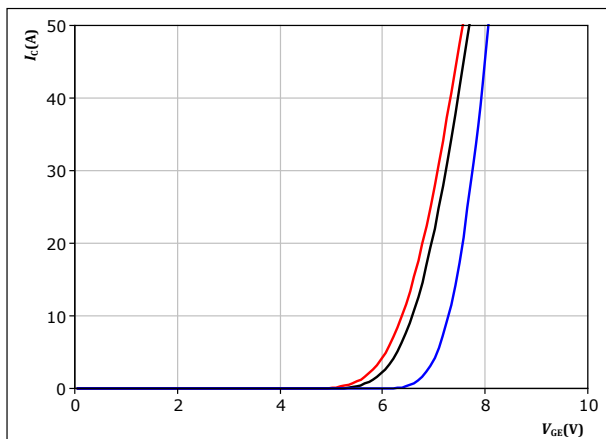


$t_p = 250 \mu s$   
 $T_j = 150 ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



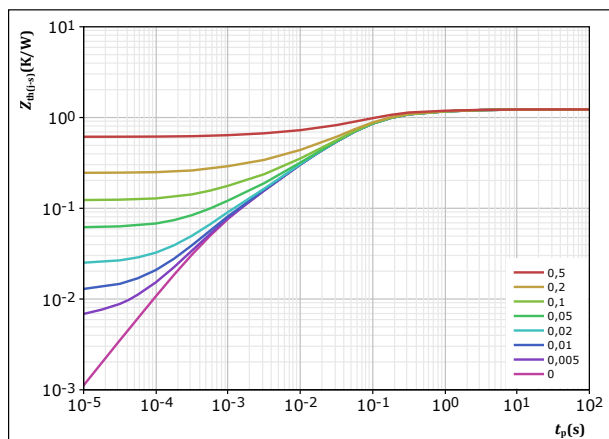
$t_p = 250 \mu s$   
 $V_{CE} = 10 V$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1,228 K/W$   
IGBT thermal model values  

$R (K/W)$	$\tau (s)$
5,07E-02	3,25E+00
1,43E-01	5,26E-01
5,97E-01	9,03E-02
2,58E-01	2,71E-02
1,27E-01	5,65E-03
5,33E-02	7,25E-04



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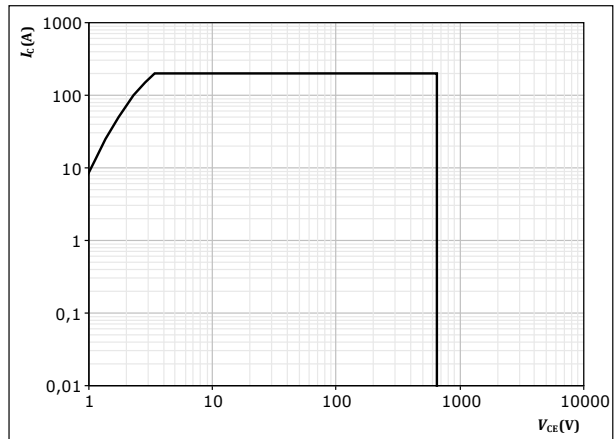
**10-FY07HVA050RG01-L984F48**  
datasheet

## Buck Switch Characteristics

**figure 5.** IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$  single pulse

$T_s = 80$  °C

$V_{GE} = 15$  V

$T_j = T_{jmax}$



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## Buck Diode Characteristics

figure 6.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

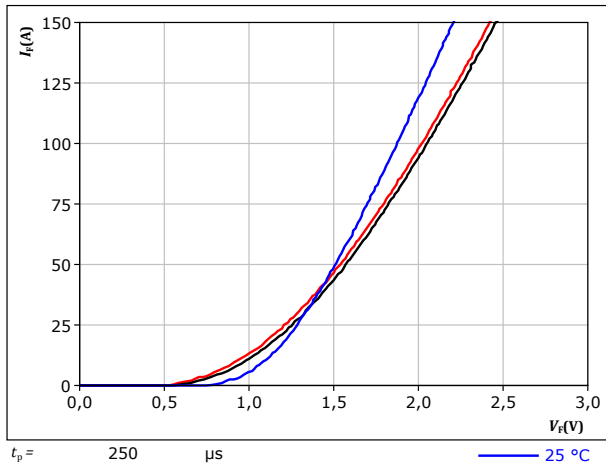
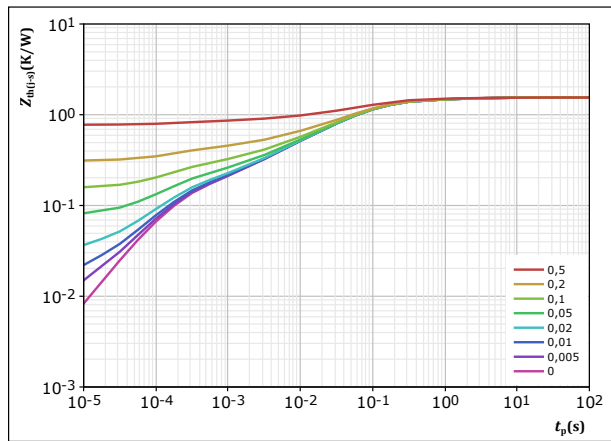


figure 7.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	1,548 K/W
FWD thermal model values	
$R$ (K/W)	$\tau$ (s)
4,44E-02	5,26E+00
1,14E-01	8,12E-01
4,83E-01	1,25E-01
4,67E-01	4,08E-02
2,41E-01	7,57E-03
7,79E-02	1,14E-03
1,22E-01	1,66E-04



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# 10-FY07HVA050RG01-L984F48

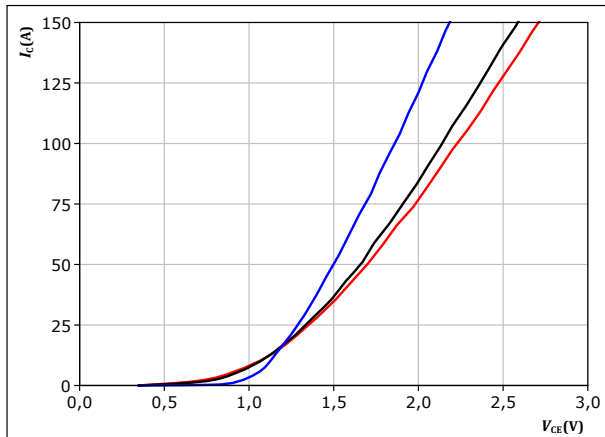
datasheet

## Boost Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

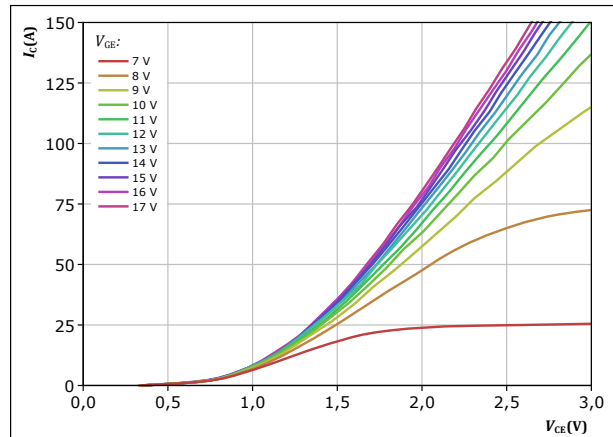


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

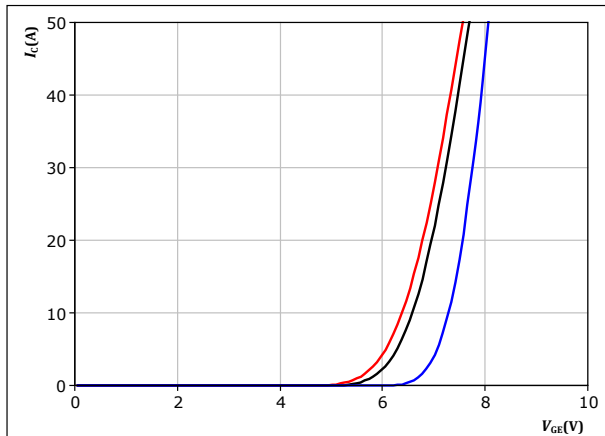


$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

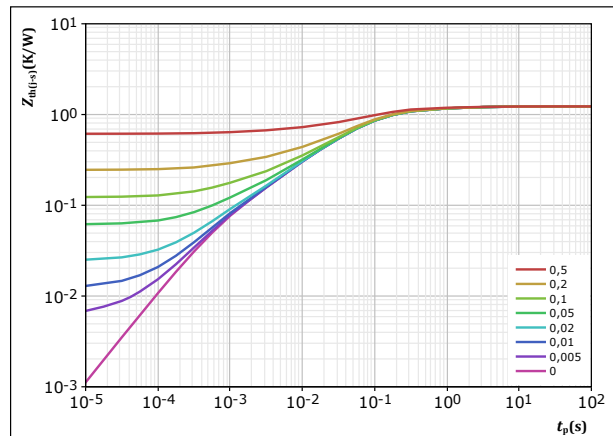


$t_p = 250 \mu s$   
 $V_{CE} = 10 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1.228 \text{ K/W}$   
IGBT thermal model values  

$R \text{ (K/W)}$	$\tau \text{ (s)}$
5.07E-02	3.25E+00
1.43E-01	5.26E-01
5.97E-01	9.03E-02
2.58E-01	2.71E-02
1.27E-01	5.65E-03
5.33E-02	7.25E-04



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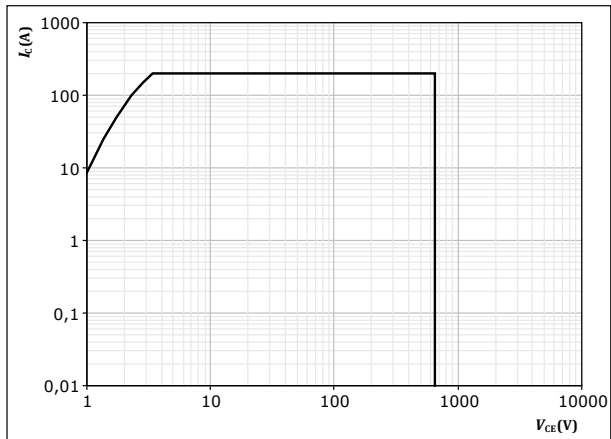
## Boost Switch Characteristics

figure 12.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D = \text{single pulse}$

$T_s = 80 \text{ } ^\circ\text{C}$

$V_{GE} = 15 \text{ V}$

$T_j = T_{jmax}$



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## Boost Diode Characteristics

figure 13.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

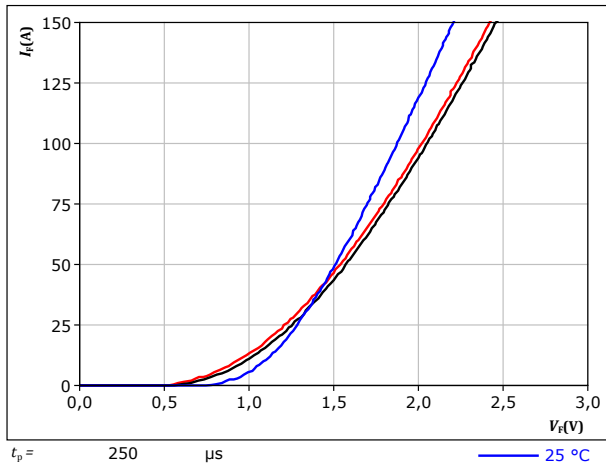
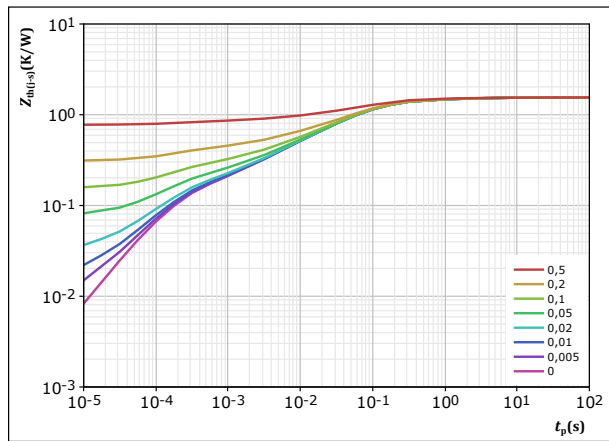


figure 14.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	1,548 K/W
FWD thermal model values	
$R$ (K/W)	$\tau$ (s)
4,44E-02	5,26E+00
1,14E-01	8,12E-01
4,83E-01	1,25E-01
4,67E-01	4,08E-02
2,41E-01	7,57E-03
7,79E-02	1,14E-03
1,22E-01	1,66E-04



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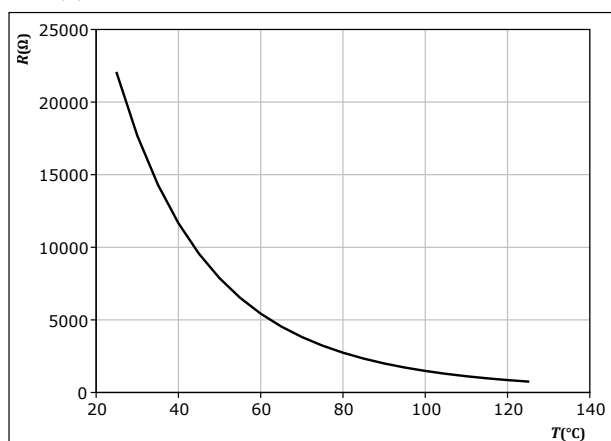
## Thermistor Characteristics

figure 15.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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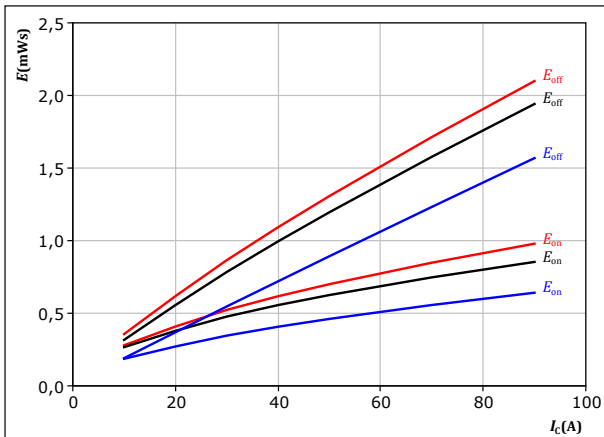
## Buck Switching Characteristics

figure 16.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$   
 $R_{goff} = 8 \text{ } \Omega$

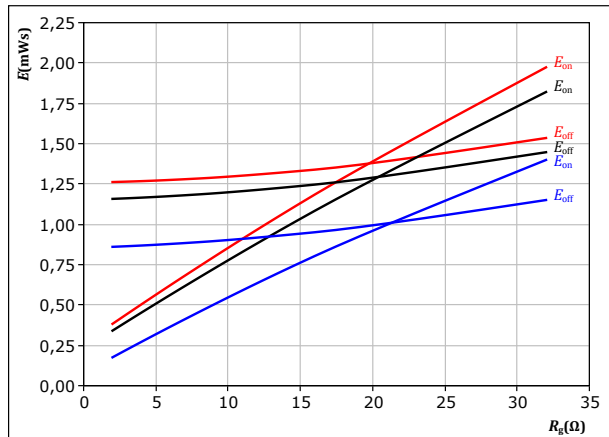
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 17.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_C = 50 \text{ A}$

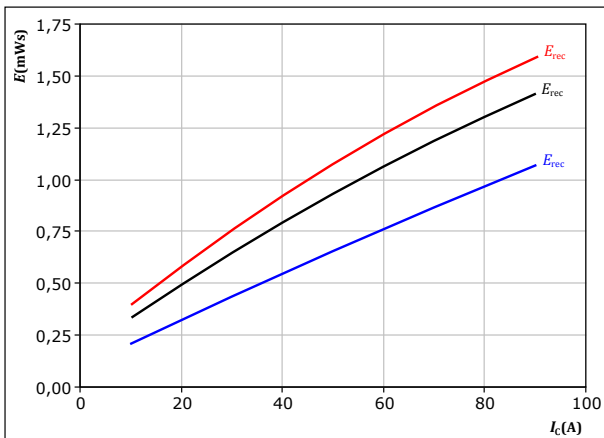
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 18.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$

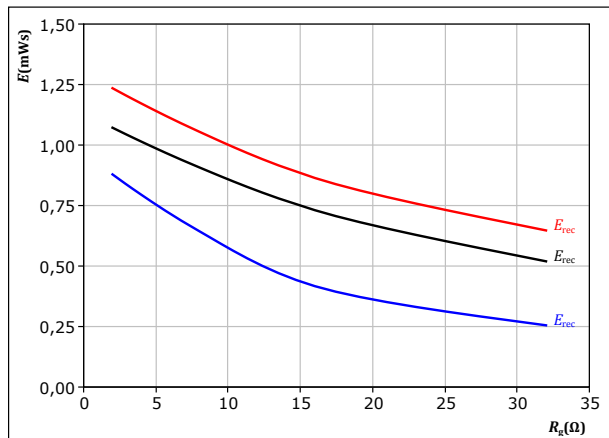
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 19.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_C = 50 \text{ A}$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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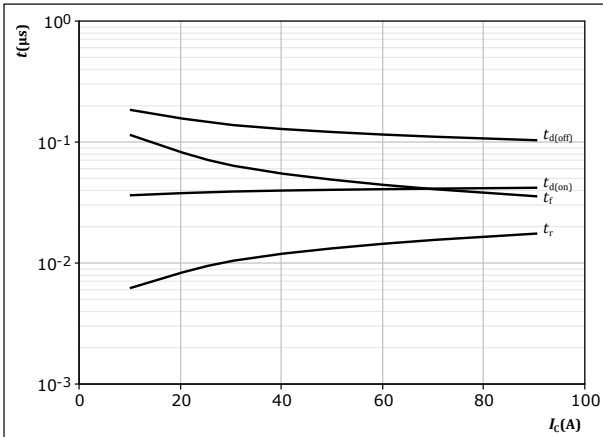
10-FY07HVA050RG01-L984F48  
datasheet

## Buck Switching Characteristics

figure 20.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_c)$



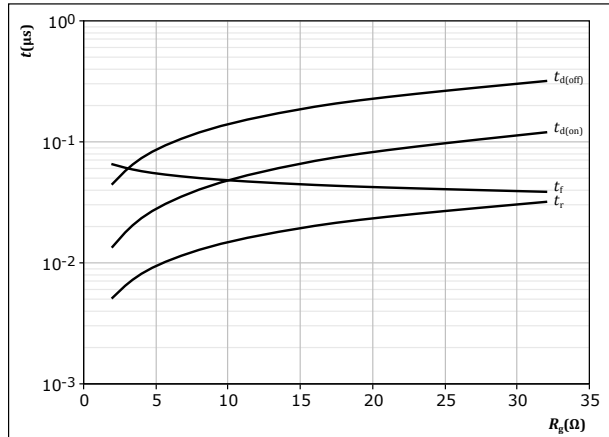
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$   $\Omega$   
 $R_{goff} = 8$   $\Omega$

figure 21.

IGBT

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



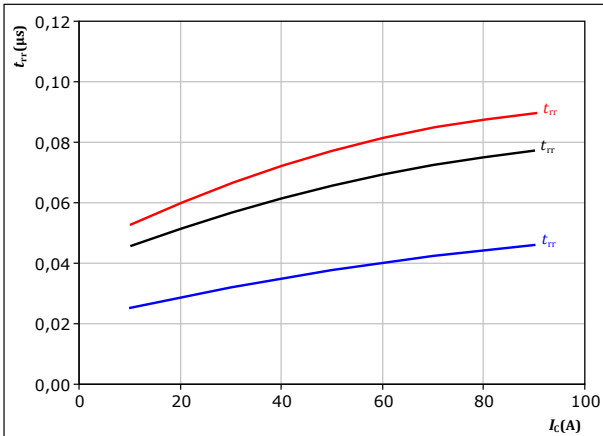
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 50$  A

figure 22.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_c)$



With an inductive load at

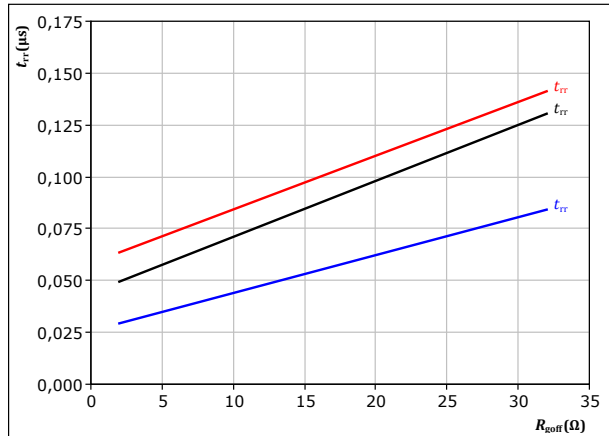
$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$   $\Omega$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 23.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 50$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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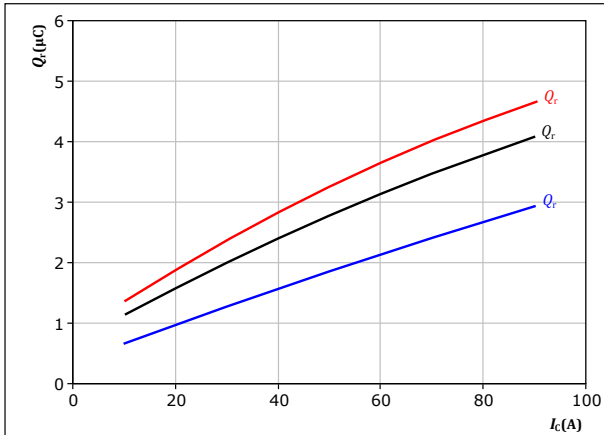
## Buck Switching Characteristics

figure 24.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$   $\Omega$

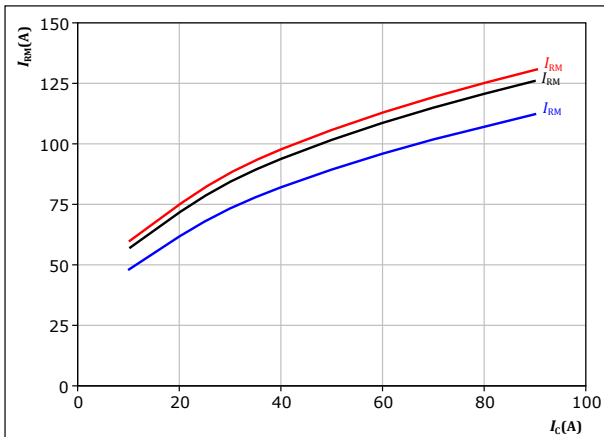
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 26.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$   $\Omega$

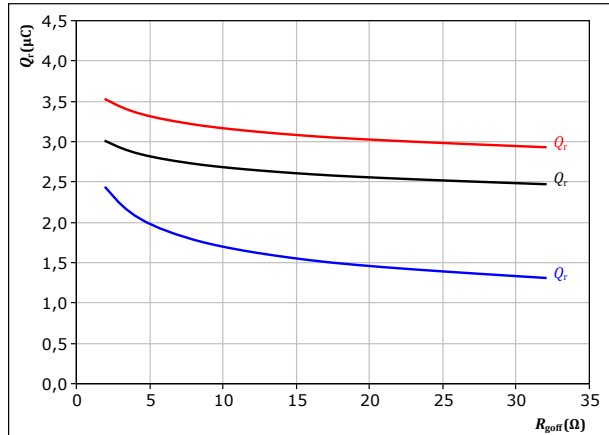
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 25.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 50$  A

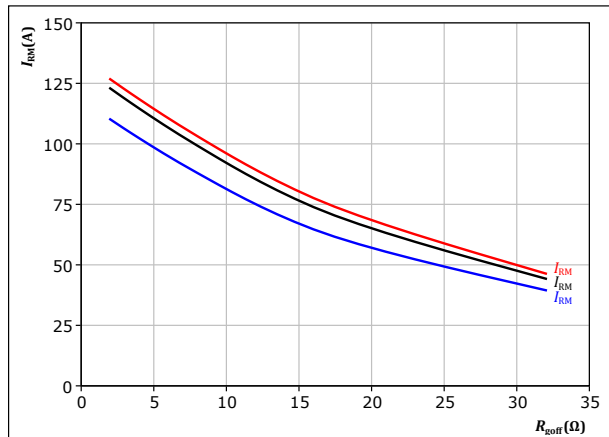
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 27.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 50$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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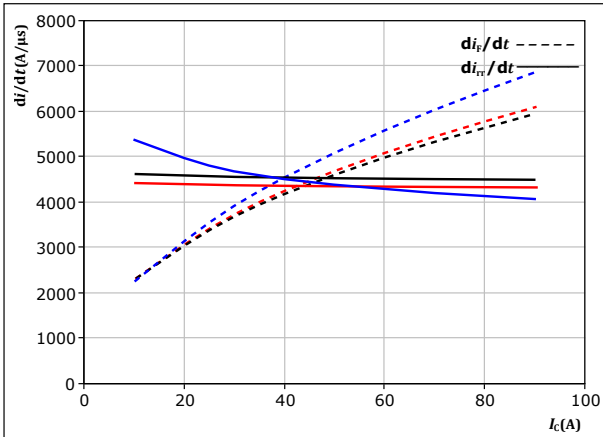
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datasheet

## Buck Switching Characteristics

figure 28.

FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_C)$



With an inductive load at

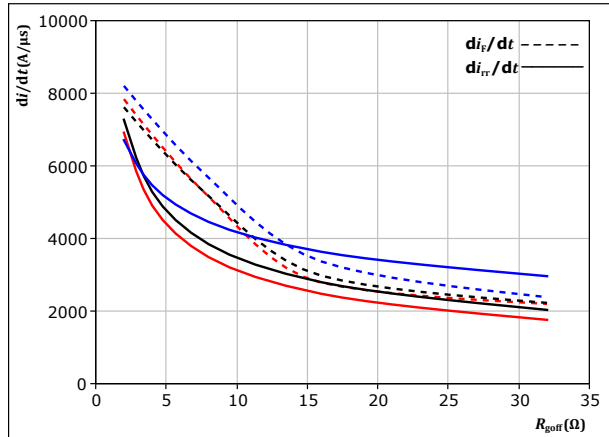
$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 29.

FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_C = 50 \text{ A}$

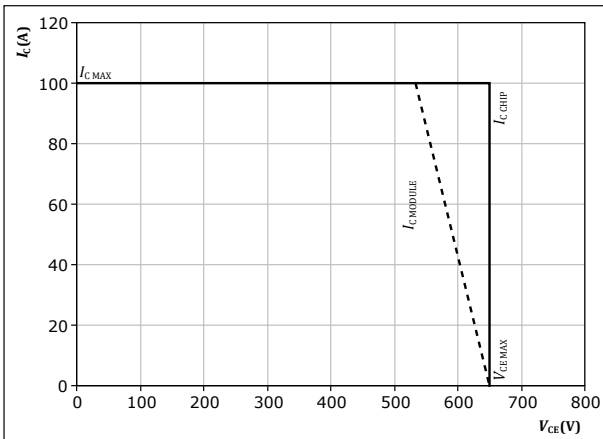
$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 30.

IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At  $T_j = 150 \text{ } ^\circ\text{C}$   
 $R_{gon} = 8 \text{ } \Omega$   
 $R_{goff} = 8 \text{ } \Omega$



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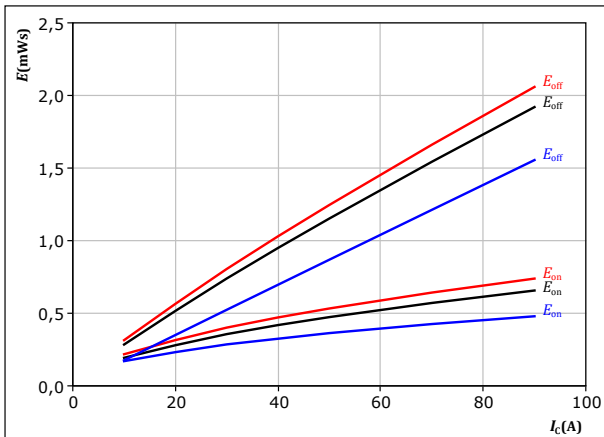
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datasheet

## Boost Switching Characteristics

figure 31. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

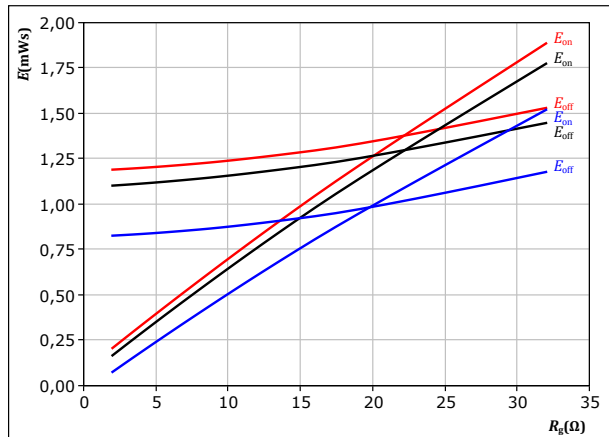
$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$   $\Omega$   
 $R_{goff} = 8$   $\Omega$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 32. IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

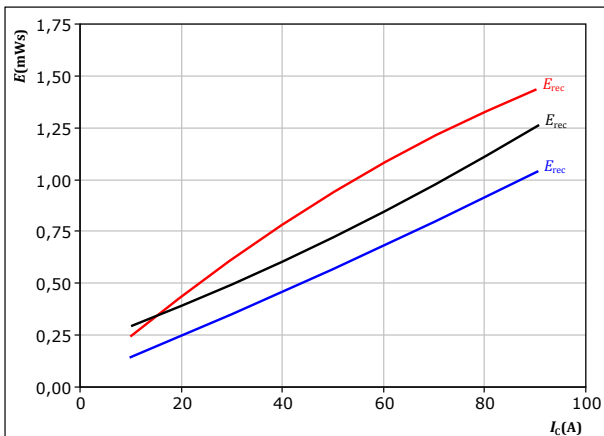
$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 50$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 33. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

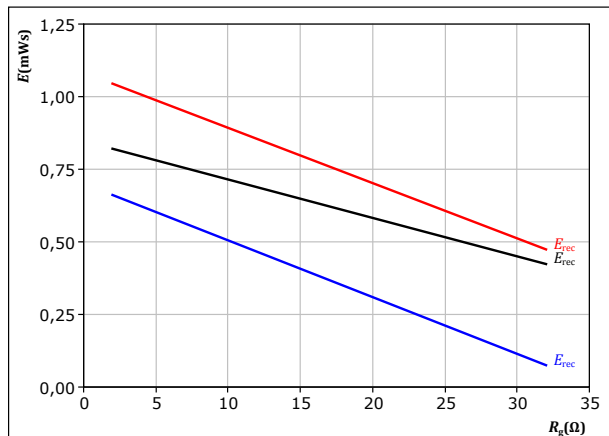
$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$   $\Omega$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 34. FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 50$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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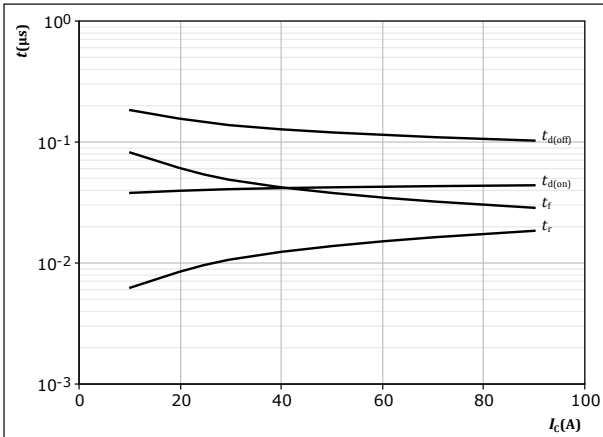
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datasheet

## Boost Switching Characteristics

figure 35.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$



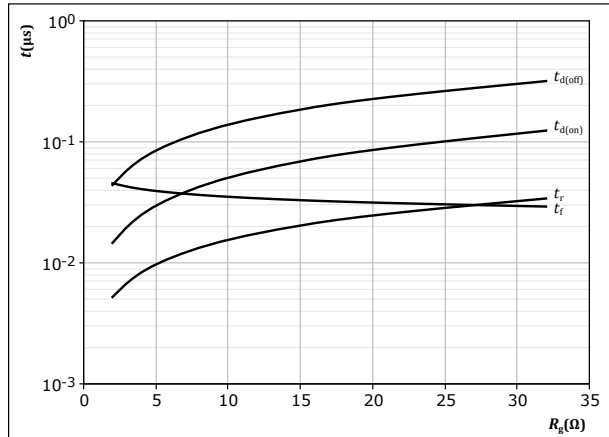
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$  Ω  
 $R_{goff} = 8$  Ω

figure 36.

IGBT

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



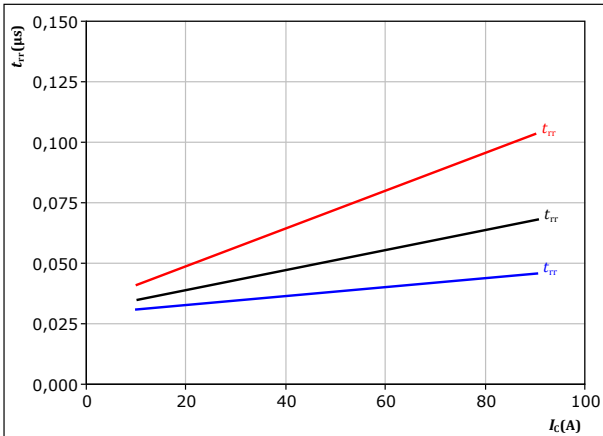
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_C = 50$  A

figure 37.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



With an inductive load at

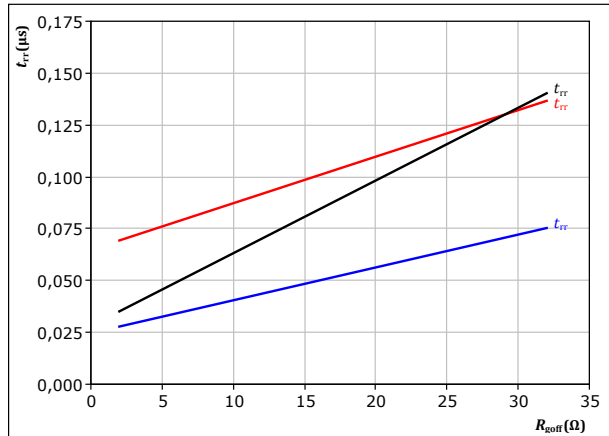
$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$  Ω

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C

figure 38.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_C = 50$  A

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C



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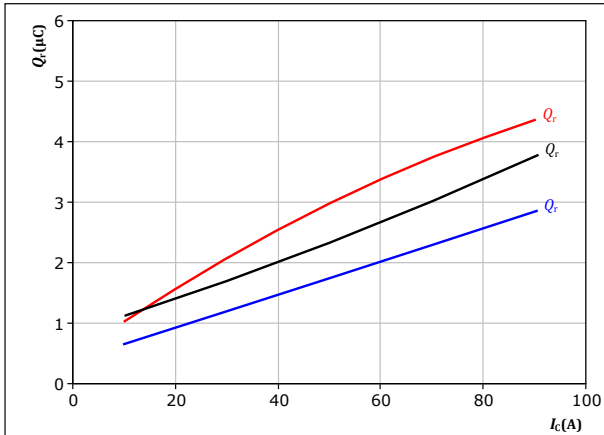
## Boost Switching Characteristics

figure 39.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_C)$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$  Ω

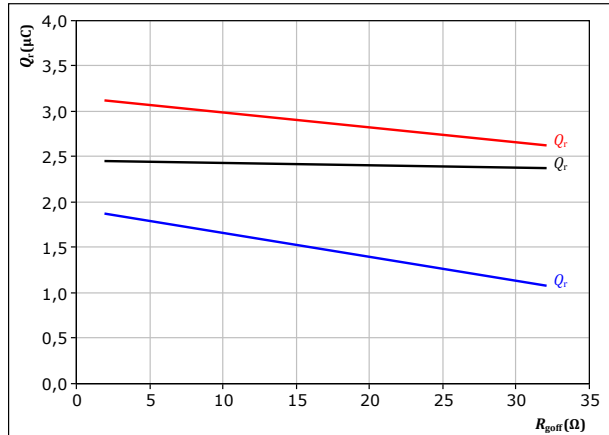
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 40.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_C = 50$  A

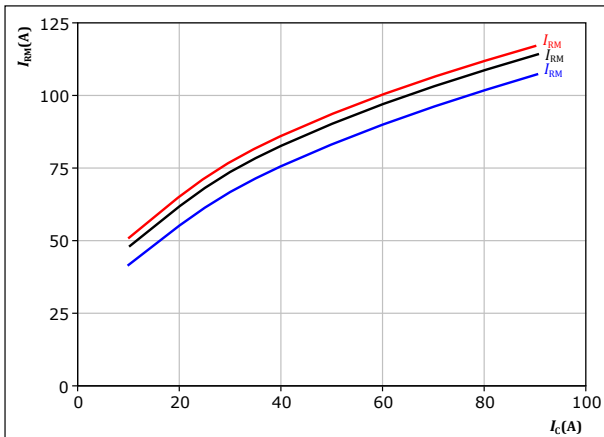
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 41.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_C)$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 8$  Ω

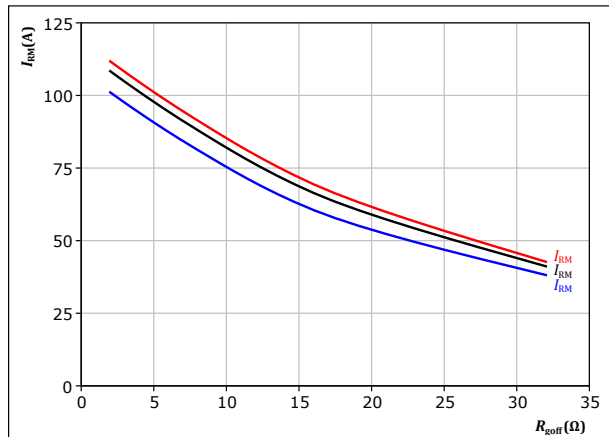
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 42.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 400$  V  
 $V_{GE} = -5/15$  V  
 $I_C = 50$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



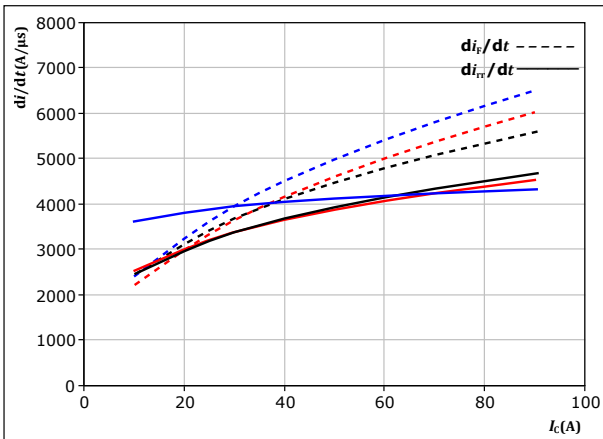
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datasheet

## Boost Switching Characteristics

figure 43. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_C)$



With an inductive load at

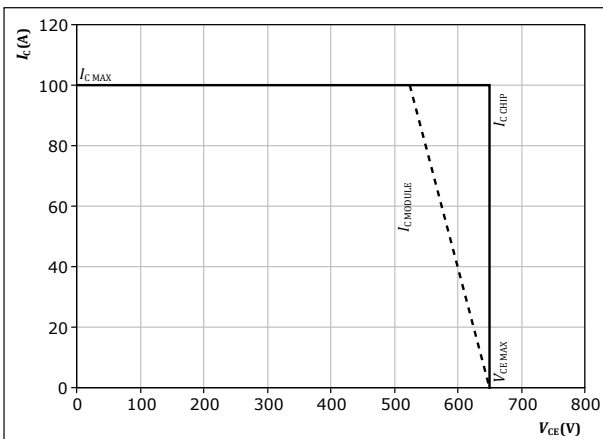
$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 45. IGBT

Reverse bias safe operating area

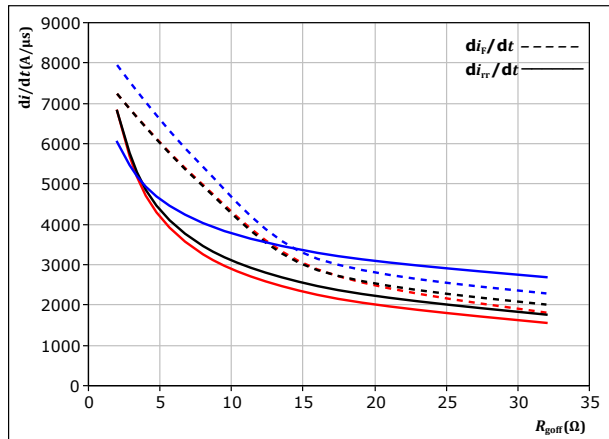
$I_C = f(V_{CE})$



At  $T_j = 150 \text{ } ^\circ\text{C}$   
 $R_{gon} = 8 \text{ } \Omega$   
 $R_{goff} = 8 \text{ } \Omega$

figure 44. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_C = 50 \text{ A}$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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## Switching Definitions

figure 46. IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

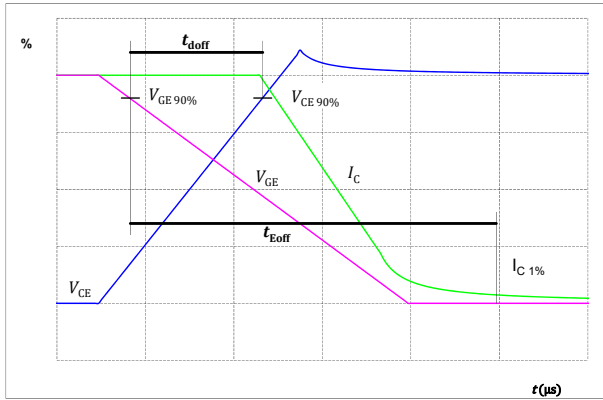


figure 47. IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

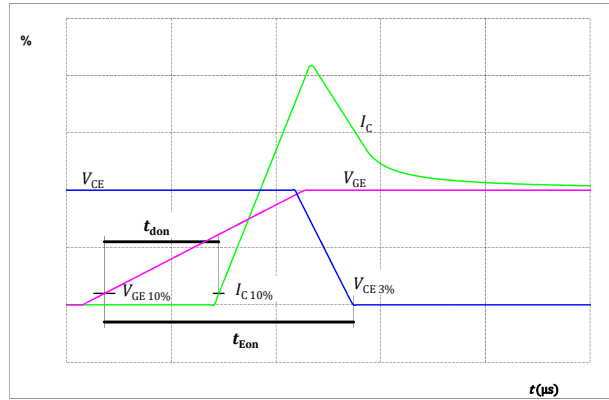


figure 48. IGBT

Turn-off Switching Waveforms & definition of  $t_f$

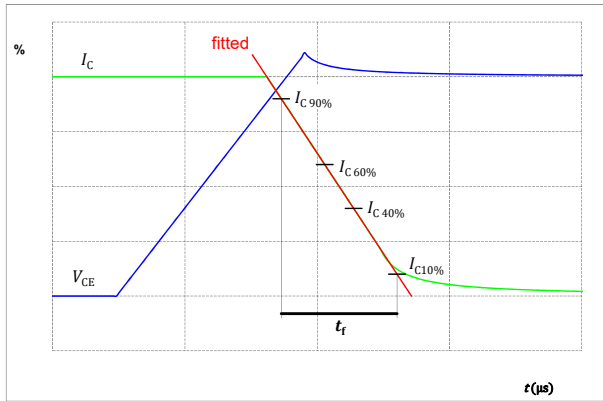
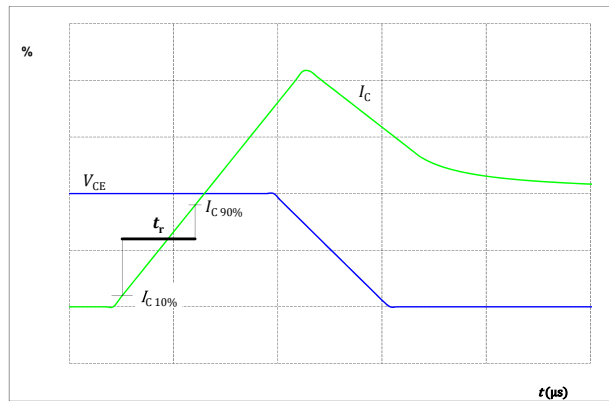


figure 49. IGBT

Turn-on Switching Waveforms & definition of  $t_r$





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## Switching Definitions

figure 50.

FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$

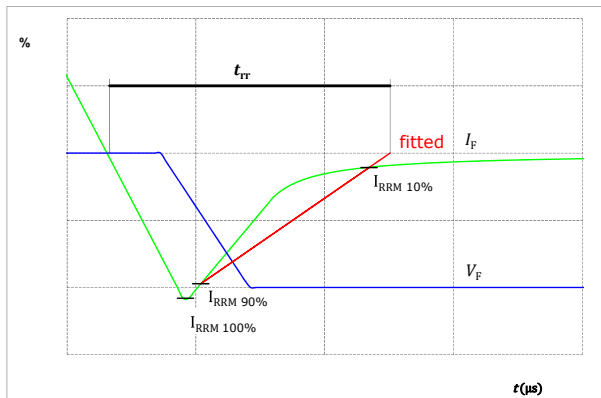
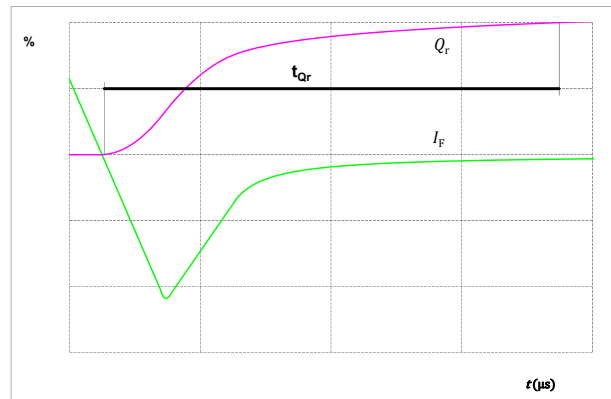


figure 51.

FWD


Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )





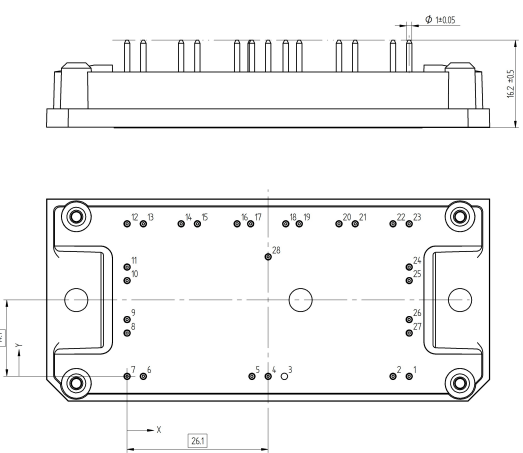
## datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-FY07HVA050RG01-L984F48
With thermal paste (5,2 W/mK, PTM6000HV)	10-FY07HVA050RG01-L984F48-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-FY07HVA050RG01-L984F48-/3/

Marking							
 <p>NV-NNNNNNNNNNNN TTTTTUVWYY-UL VIN LLLLL SSSS</p>	Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTUV		WWYY	UL VIN	LLLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTIV	LLLLL	SSSS	WWYY			

Outline
Pin table [mm]

Pin	X	Y	Function
1	52,2	0	G14
2	49,2	0	S14
3	not assembled		
4	26,1	0	Therm2
5	23,1	0	Therm1
6	3	0	S12
7	0	0	G12
8	0	8	DC+
9	0	10,5	DC+
10	0	17,7	DC-1
11	0	20,2	DC-1
12	0	28,2	G11
13	3	28,2	S11
14	10	28,2	G21
15	13	28,2	S21
16	20,35	28,2	Ph2
17	22,85	28,2	Ph2
18	29,35	28,2	Ph1
19	31,85	28,2	Ph1
20	39,2	28,2	S22
21	42,2	28,2	G22
22	49,2	28,2	S13
23	52,2	28,2	G13
24	52,2	20,2	DC-2
25	52,2	17,7	DC-2
26	52,2	10,5	DC+
27	52,2	8	DC+
28	26,1	22,1	A20



Tolerance of pinpositions: ±0.5mm at the end of pins

Dimension of coordinate axis is only offset without tolerance

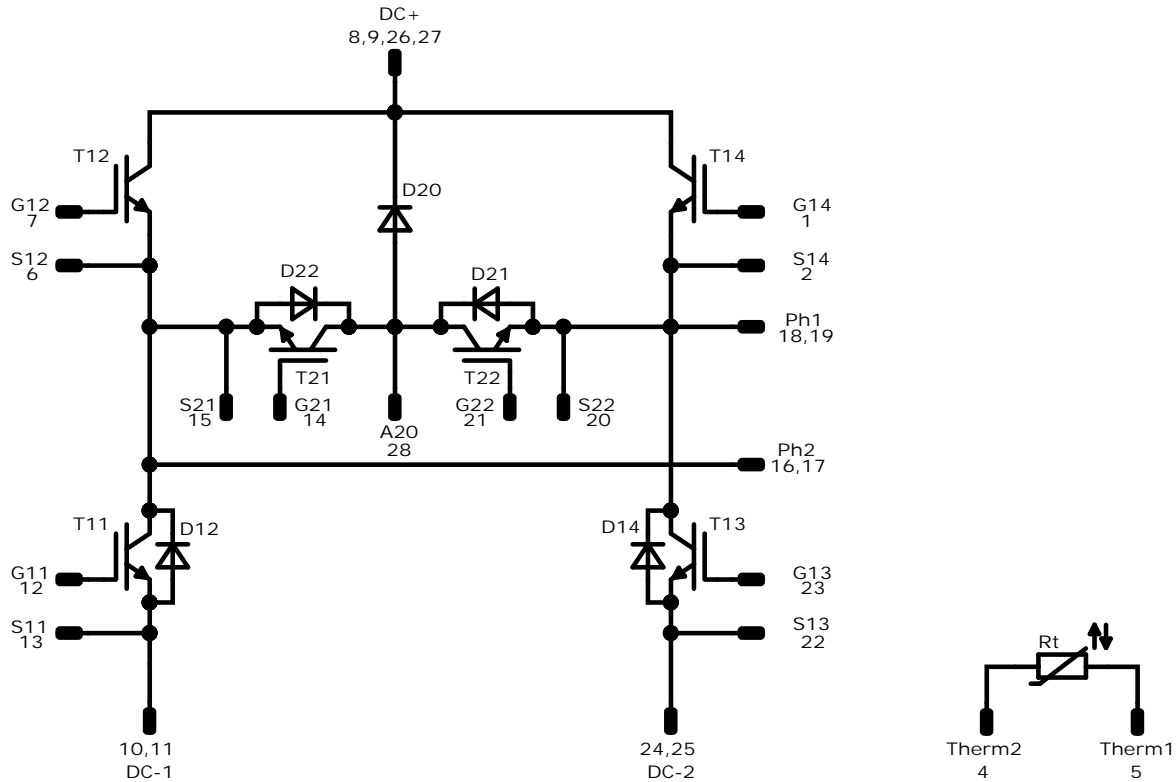


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# 10-FY07HVA050RG01-L984F48

datasheet

## Pinout



## Identification

ID	Component	Voltage	Current	Function	Comment
T11, T13, T12, T14	IGBT	650 V	50 A	Buck Switch	
D22, D21	FWD	650 V	50 A	Buck Diode	
T21, T22	IGBT	650 V	50 A	Boost Switch	
D12, D14, D20	FWD	650 V	50 A	Boost Diode	
Rt	NTC			Thermistor	



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**10-FY07HVA050RG01-L984F48**  
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-FY07HVA050RG01-L984F48-D1-14	23 Jan. 2022	Initial Release	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.